

CONTACT MATERIAL; COPPER TIN ALLOY
CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING
ON THE CONTACT TAILS, NICKEL UNDERPLATE

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MASTER	
DRAWN: R.STA.MONICA	DATE:MAY.16/2017
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SCALE: 1:1	SHEET 1 OF 2
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- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL; COPPER ALLOY

CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

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Mouser Electronics

Authorized Distributor

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